PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

EPAS ID: PAT2963055

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
VENKATRAMAN IYER	06/20/2013
DARREN S. JUE	07/08/2013
SITARAMAN V. IYER	06/29/2013

RECEIVING PARTY DATA

Name:	INTEL CORPORATION
Street Address:	2200 MISSION COLLEGE BLVD
City:	SANTA CLARA
State/Country:	CALIFORNIA
Postal Code:	95054

PROPERTY NUMBERS Total: 1

Property Type	Number
PCT Number:	US2013032699

CORRESPONDENCE DATA

Fax Number: (612)677-3572

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 214-823-1241

Email: klodermeier@cpaglobal.com PATENT CAPITAL GROUP **Correspondent Name:**

Address Line 1: C/O CPA GLOBAL Address Line 2: PO BOX 52050

Address Line 4: MINNEAPOLIS, MINNESOTA 55402

ATTORNEY DOCKET NUMBER:	P50881PCT
NAME OF SUBMITTER:	KEITH LODERMEIER
SIGNATURE:	/Keith Lodermeier/
DATE SIGNED:	07/31/2014

Total Attachments: 6

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ASSIGNMENT

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, we, the undersigned inventor(s):

VENKATRAMAN IYER: DARREN S. JUE; SITARAMAN V. IYER

hereby sell, assign, and transfer to:

Intel Corporation

a corporation of Delaware, having a principal place of business at 2200 Mission College Boulevard, Santa Clara, California, 95054 USA ("Assignee"), and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States and all foreign countries, in and to any and all inventions and improvements that are disclosed in the International application entitled:

HIGH PERFORMANCE INTERCONNECT PHYSICAL LAYER

(I hereby authorize and request my attorney, associated with Customer Number 97298, to insert on the designated lines below, the filing date and application number of said application when known.)

March 15, 2013 as

which was filed on	March	15, 2013 _ as	
International Application	Number	PCT/US2013/032699	and

which has been executed by the undersigned prior hereto or concurrently herewith on the date(s) indicated below,

and in and to said international application and all related applications (e.g. national phase applications, divisional applications, continuation applications, reexaminations, reissues, and the like) that have been or shall be filed in the United States and/or all foreign countries on said inventions and improvements, as well as in and to all rights of priority resulting from the filing of said International application;

agree that said Assignee may apply for and receive a patent or patents for said inventions and improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns, and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all design, utility, divisional, continuing, continuation-in-part, substitute, renewal, reissue, and all other patent applications on any and all said inventions and improvements; execute all rightful oaths, assignments, powers of attorney, and other papers; communicate to said Assignee, its successors, assigns, and legal representatives all facts known to the undersigned relating to said inventions and improvements and the history thereof; and generally assist said Assignee, its successors, assigns, or legal representatives in securing and maintaining proper patent protection for said inventions and improvements and for vesting title to said inventions and improvements, and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

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covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Venhatra Inc. IYER, Venkatraman	6 20 20 3 (Today's Date)
IIII, Voikananan	(Today 5 Date)
JUE, Darren S.	(Today's Date)
IYER, Sitaraman V.	(Today's Date)

LGA/PAL forms Page 2 of 2

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hereby sell, assign, and transfer to:

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agree that said Assignee may apply for and receive a patent or patents for said inventions and improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns, and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all design, utility, divisional, continuing, continuation-in-part, substitute, renewal, reissue, and all other patent applications on any and all said inventions and improvements; execute all rightful oaths, assignments, powers of attorney, and other papers; communicate to said Assignee, its successors, assigns, and legal representatives all facts known to the undersigned relating to said inventions and improvements and the history thereof; and generally assist said Assignee, its successors, assigns, or legal representatives in securing and maintaining proper patent protection for said inventions and improvements and for vesting title to said inventions and improvements, and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

Page 1 of 2 LGA/PAL forms

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IYER, Venkatraman	(Today's Date)
Sanles	7/8/13
JUE, Darren S.	(Today's Date)
INTED Citymon V	(Today's Date)
IYER, Sitaraman V.	(Today

Page 2 of 2

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International Application Number PCT US2013.012600 and

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IYER, Venkatraman (Today's Date)

JUE, Darren S. (Today's Date)

TUNE 29, 2013

IYER, Sitaraman V. (Today's Date)